KEMET Part Number: C0603X330G1HACTU

(C0603X330G1HAC7867)



SMD Comm X8R HT150C Flex, Ceramic, 33 pF, 2%, 100 VDC, X8R, SMD, MLCC, High Temperature, Ultra-Stable, 0603



Dimensions		
Chip Size	0603	
L	1.6mm +/-0.17mm	
W	0.8mm +/-0.15mm	
Т	0.8mm +/-0.15mm	
S	0.58mm MIN	
В	0.45mm +/-0.15mm	

Packaging Specifications		
Packaging:	T&R, 180mm, Paper Tape	
Packaging Quantity:	4000	

General Information		
Series:	SMD Comm X8R HT150C Flex	
Style:	SMD Chip	
Description:	SMD, MLCC, High Temperature, Ultra-Stable	
Features:	Ultra-Stable	
RoHS:	Yes	
Termination:	Flexible Termination	
Marking:	No	
AEC-Q200:	No	
Component Weight:	7300 ug	
Shelf Life:	78 Weeks	
MSL:	1	

Specifications		
Capacitance:	33 pF	
Measurement Condition:	1 MHz 1.0Vrms	
Capacitance Tolerance:	2%	
Voltage DC:	100 VDC	
Dielectric Withstanding Voltage:	250 VDC	
Temperature Range:	-55/+150°C	
Temperature Coefficient:	X8R	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	15%, 1MegaHz 1.0Vrms	
Dissipation Factor:	2.5% 1 MHz 1.0Vrms	
Aging Rate:	0% Loss/Decade Hour: Referee Time is 1000 Hours	
Insulation Resistance:	100 GOhms	

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.



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